TOSHIBA Photo−Interrupter Infrared LED+Phototransistor

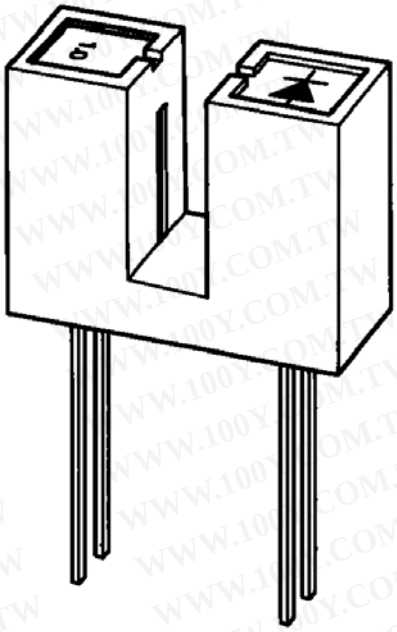
TLP801A

Optical Switches

Position And Rotation Detection

Position Detection In FDDS(Floppy Disk Drives)

Timing Detection In Copiers, Printers, Fax Machines, Etc.



TOSHIBA 11−13D2

Weight: 0.78g(typ.)

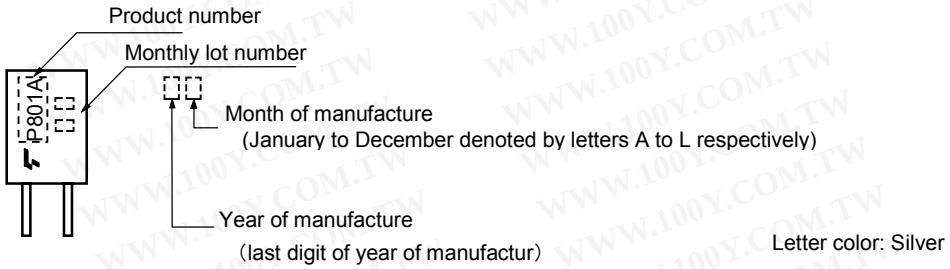
The TLP801A photo−interrupter can be used for high-speed position detection.

- Gap: 3mm
- Resolution: Slit width = 1mm
- Fast response speed: t_r, t_f = 6μs(typ.)
- High current transfer ratio: I_C / I_F = 10%(min)
- Designed for direct mounting on printed circuit boards
- Package material: Polycarbonate

Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit
LED	Forward current	I_F	50	mA
	Forward current derating (Ta > 25°C)	ΔI_F / °C	−0.33	mA / °C
	Reverse voltage	V_R	5	V
Detector	Collector−emitter voltage	V_{CEO}	30	V
	Emittercollector voltage	V_{ECO}	5	V
	Collector power dissipation	P_C	75	mW
	Collector power dissipation derating(Ta > 25°C)	ΔP_C / °C	−1	mW / °C
	Collector current	I_C	50	mA
Operating temperature range		T_{opr}	−25~85	°C
Storage temperature range		T_{stg}	−40~100	°C

Markings



Letter color: Silver

Optical And Electrical Characteristics(Ta = 25°C)

	Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
LED	Forward voltage	V_F	I_F = 10mA	1.00	1.15	1.30	V
	Reverse current	I_R	V_R = 5V	—	—	10	μA
	Peak emission wavelength	λ_P	I_F = 20mA	—	940	—	nm
Detector	Dark current	$I_D(I_{CEO})$	V_{CE} = 24V, I_F = 0	—	—	0.1	μA
	Peak sensitivity wavelength	λ_P		—	820	—	nm
Coupled	Current transfer ratio	I_C / I_F	V_{CE} = 5V, I_F = 20mA	10	—	165	%
	Collector−emitter saturation voltage	$V_{CE(sat)}$	I_F = 20mA, I_C = 1mA	—	0.15	0.4	V
	Rise time	t_r	V_{CC} = 5V, I_C = 2mA, R_L = 100Ω	—	6	—	μs
	Fall time	t_f		—	6	—	

Precautions

The following points must be borne in mind.

1. Soldering temperature: 260°C max
   Soldering time: 5s max
   (Soldering must be performed 1.5mm under the package body.)
2. Clean only the soldered part of the leads. Do not immerse the entire package in the cleaning solvent.
3. Mount the device on a level surface.
4. Screws should be tightened to a clamping torque of 0.59 N・m.
5. The package is made of polycarbonate. Polycarbonate is usually stable with acid, alcohol and aliphatic hydrocarbons, however, with petrochemicals (such as benzene, toluene and acetone), alkalis, aromatic hydrocarbons, or chloric hydrocarbons, polycarbonate may crack, swell or melt.
   Please take this into account when chosing a packaging material by refering to the table below.

<Chemicals Which Should Not Be Used With Polycarbonate>

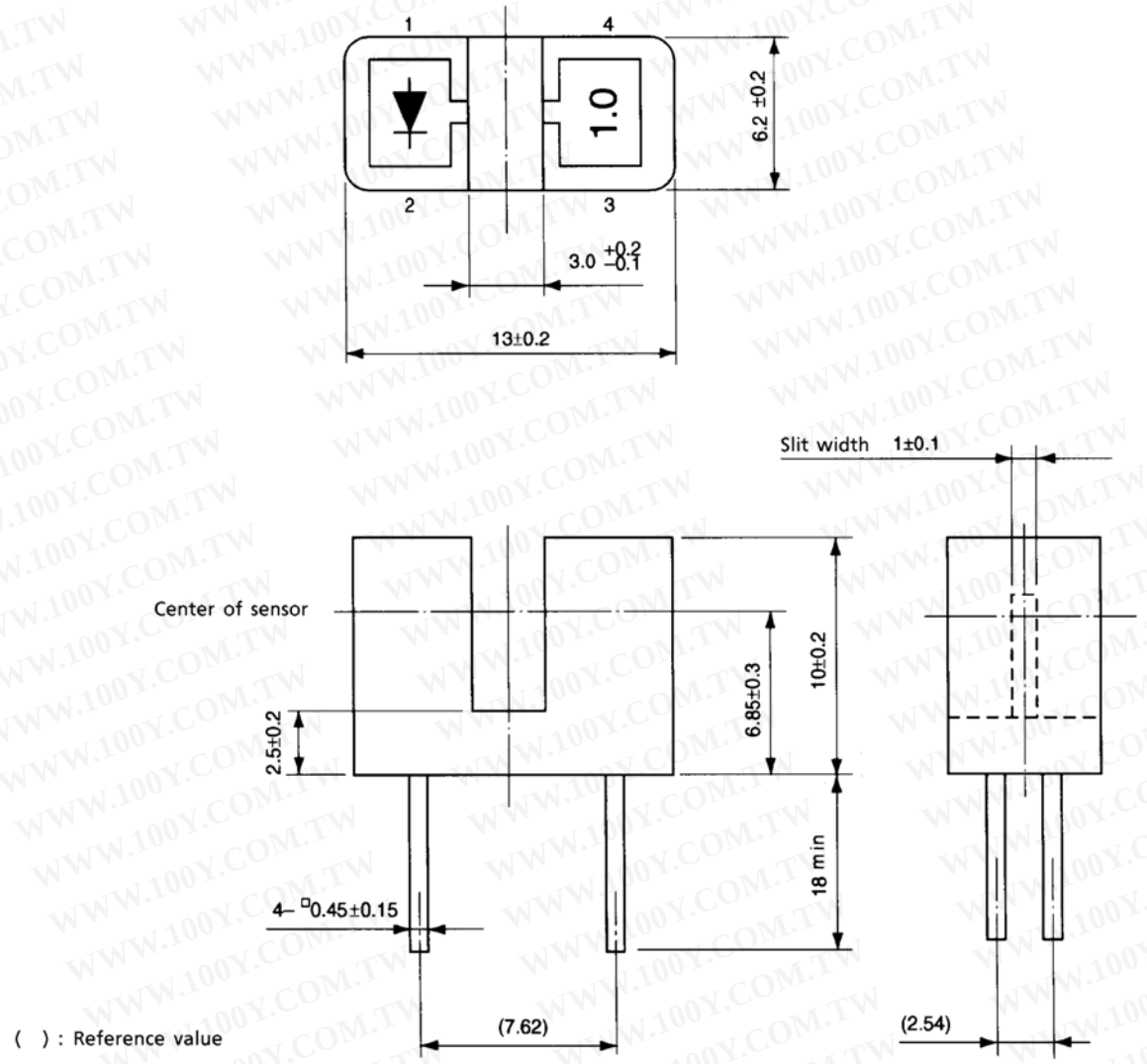
	Phenomenon	Chemicals
A	Staining and slight deterioration	・Nitric acid (diluted), hydrogen peroxide, chlorine
B	Cracking, crazed or swelling	・Acetic acid (70% or more) ・Gasoline ・Methyl ethyl ketone, ethyl acetate, butyl acetate ・Ethyl methacrylate, ethyl ether, MEK ・Acetone, m–amino alcohol, carbon tetrachloride ・Carbon disulfide, trichloroethylene, cresol ・Thinners,oil of turpentine ・Triethanolamine, TCP, TBP
C	Melting ( ): Used as solvent	・Concentrated sulfuric acid ・Benzene ・Styrene, acrylonitrile, vinyl acetate ・Ethylenediamine, diethylenediamine ・(Chloroform, methyl chloride, tetrachloromethane,dioxane, 1, 2–dichloroethane)
D	Decomposition	・Ammonia water ・Other alkalis

6. Conversion efficiency falls over time due to current which flows in the infrared LED.
   When designing a circuit, take into account this change in conversion efficiency over time.
   The ratio of fluctuation in conversion efficiency to fluctuation in infrared LED optical output is 1 : 1.

$$\frac{I_C / I_F (t)}{I_C / I_F (0)} = \frac{P_O (t)}{P_O (0)}$$

Package Dimensions

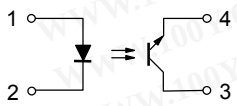
11-13D2 Unit : mm



( ) : Reference value

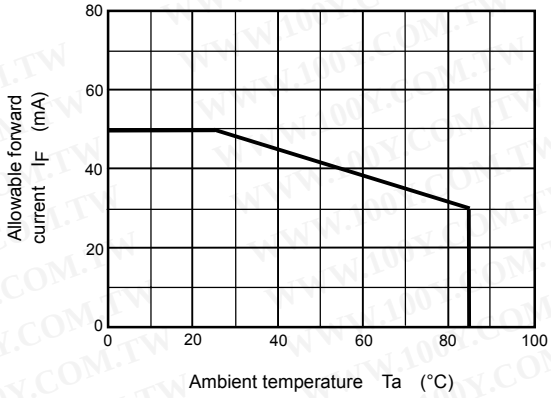
Weight: 0.78g(typ.)

Pin Connection

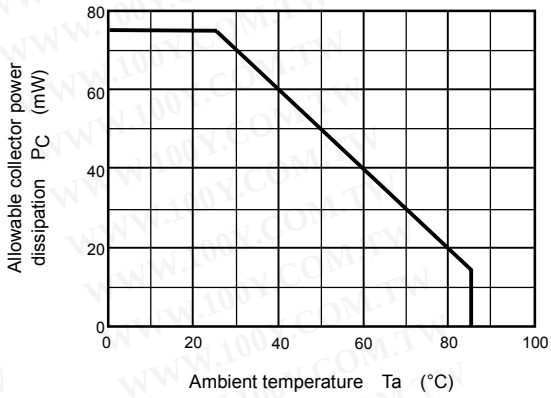


1. Anode
2. Cathode
3. Collector
4. Emitter

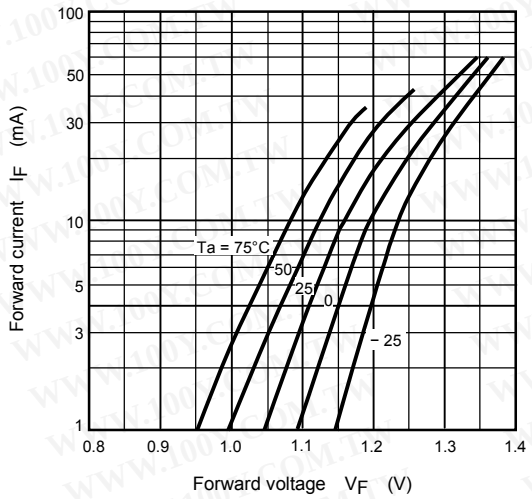
$I_F - Ta$



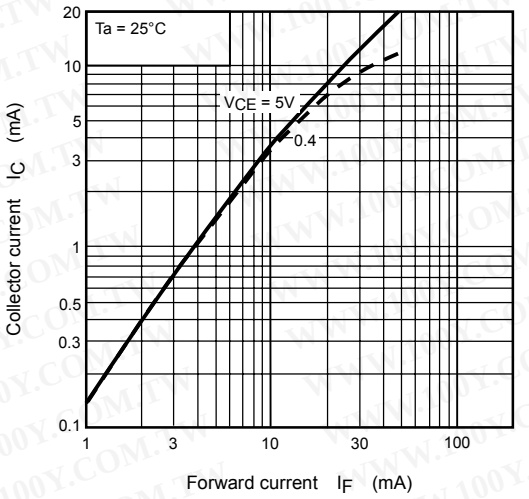
$P_C - Ta$



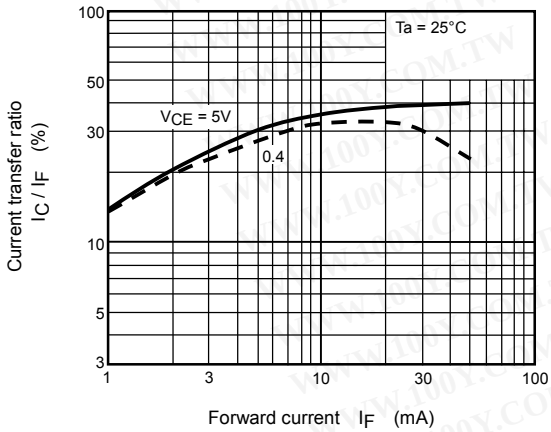
$I_F - V_F$ (typ.)



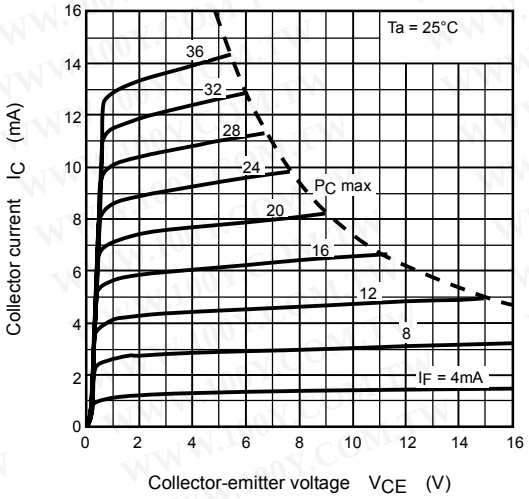
$I_C - I_F$ (typ.)



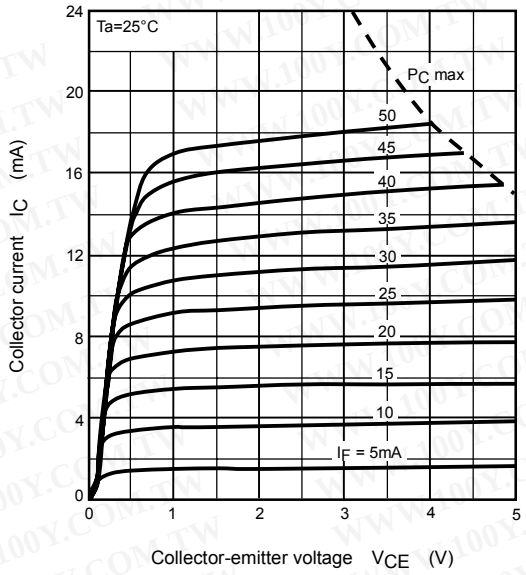
$I_C / I_F - I_F$ (typ.)



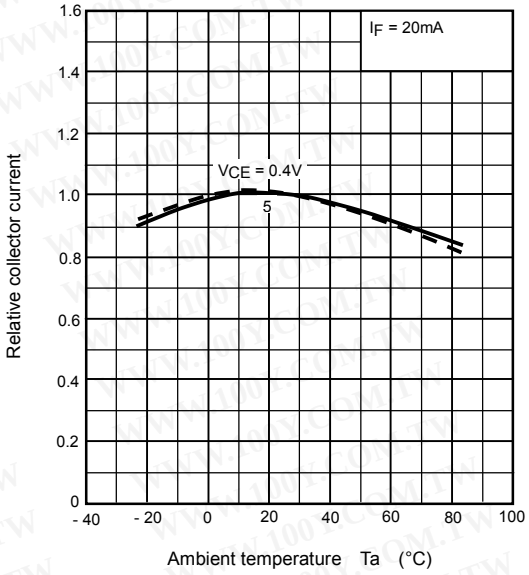
$I_C - V_{CE}$ (typ.)



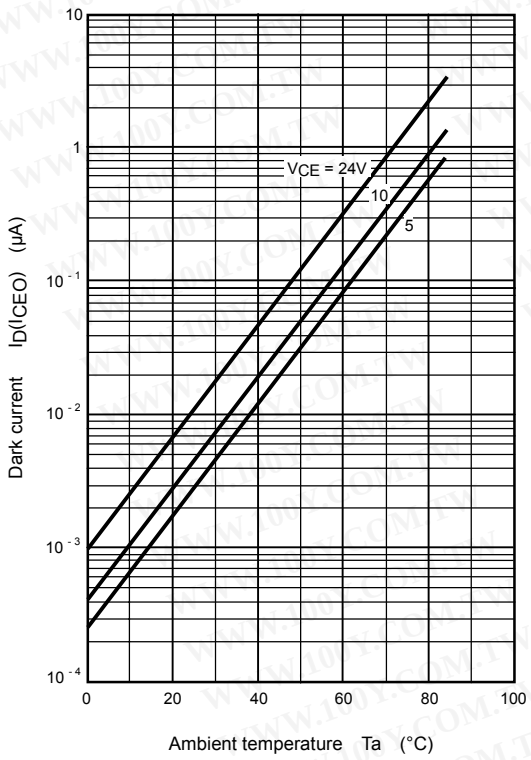
$I_C - V_{CE}$ (typ.)



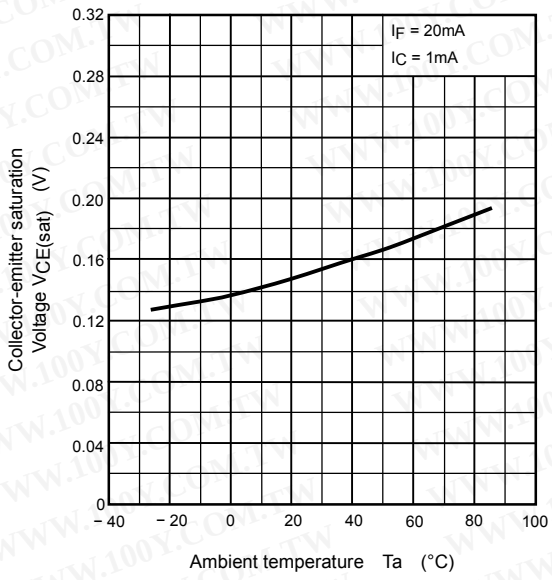
Relative I_C – Ta (tyg.)



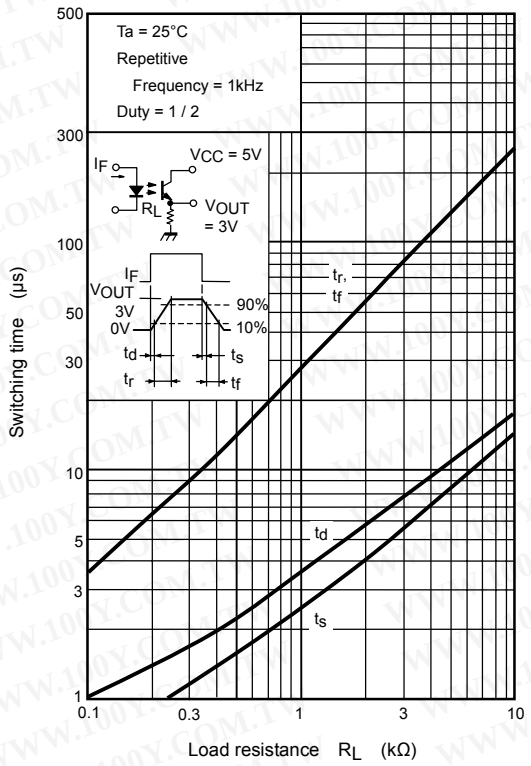
I_D (I_{CEO}) – Ta (typ.)



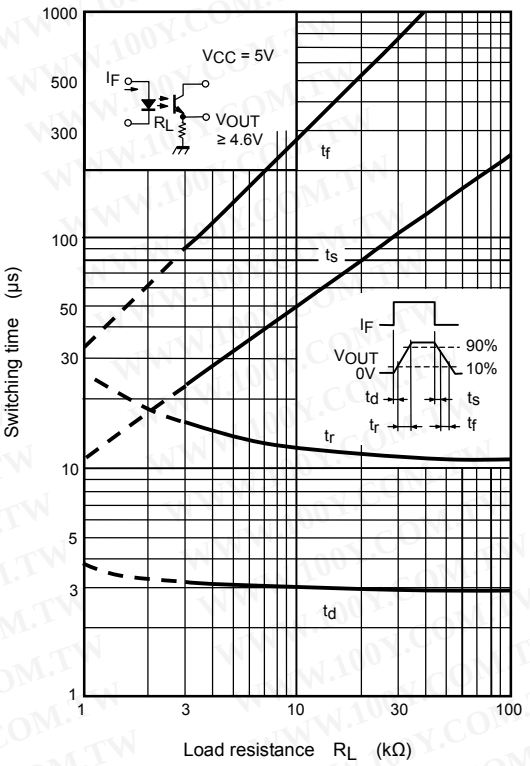
$V_{CE(sat)}$ – Ta (typ.)



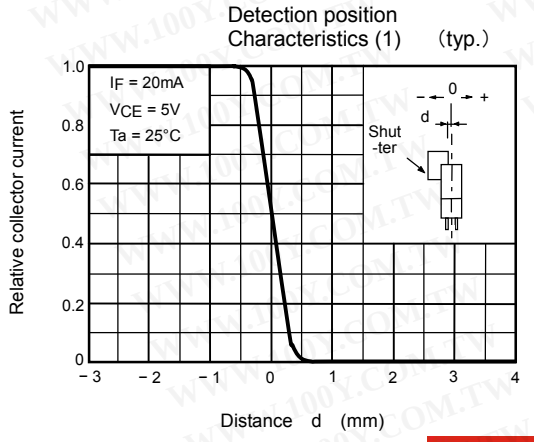
Switching characteristics
(non saturated operation) (typ.)



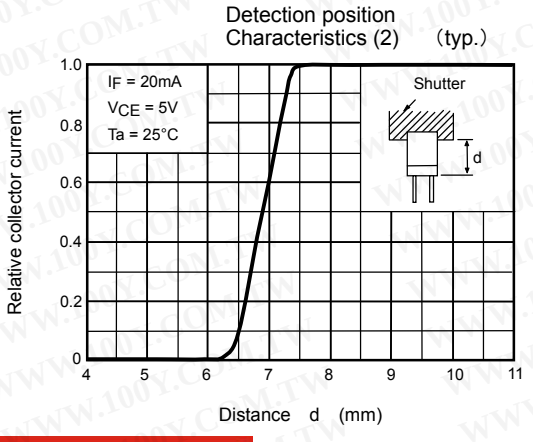
Switching characteristics
(saturated operation) (typ.)



Detection position
Characteristics (1) (typ.)

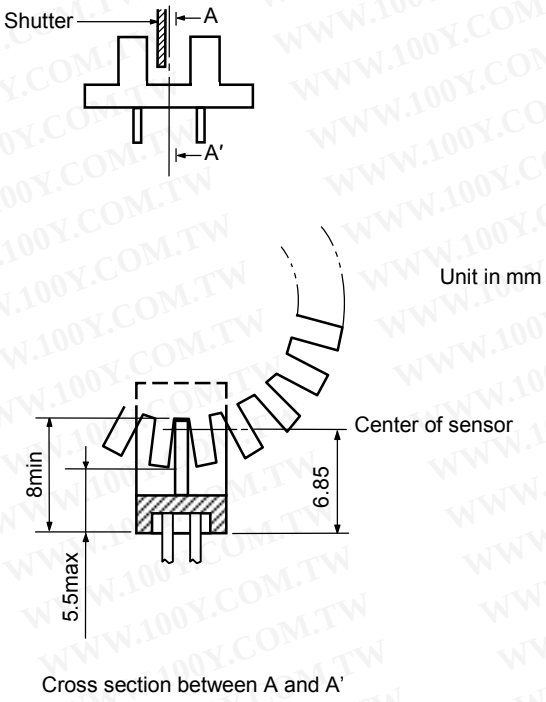


Detection position
Characteristics (2) (typ.)



Relative Positioning Of Shutter And Device

For normal operation position the shutter and the device as shown in the figure below. By considering the device's detection direction characteristic and switching time, determine the shutter slit width and pitch.



Cross section between A and A'

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